

CSE 4305 Computer Organization and Architecture

Basic Concepts

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Organization and Architecture

Distinction between "Computer Architecture" and "Computer Organization"



Computer Architecture

- Refers those attributes of a system visible to a programmer (programmer is aware of its presence)
- Has direct impact on the logical execution of a program
- Often used as Instruction Set Architecture (ISA) instruction format, instruction opcodes, registers, instruction and data memory; effect of execution instruction on the registers and memory; algorithm for controlling instruction execution.
- Logical Components Instruction set, addressing modes, data types, cache optimization



Computer Organization

- Refers to operational units and their interconnections according to the architectural specifications (implement of architecture)
- Includes physical components control signals, interface, memory technology, circuit design, adders, peripherals
- Hardware details which is transparent to the programmer (programmer is not aware of its presence)



Example

To multiply two integer numbers

Architectural Issue – whether a computer use a multiply instruction

Organizational Issue – whether that instruction will be implemented by a multiply unit or repeated use of the add unit



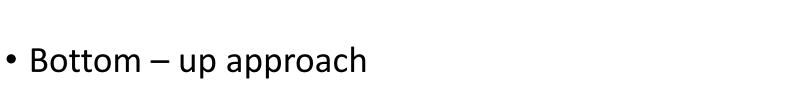
And More...

- There is a family of computer models having **same architecture** but **different organizations**. Because it will protect the customer's software investment. (Old soft wares [e.g. from Windows XP] are still runnable in Windows 10!!!)
- Changes in technology not only influence organization but also result in the introduction of more powerful and more complex architecture
- But they have less requirement for generation to generation compatibility for smaller machines

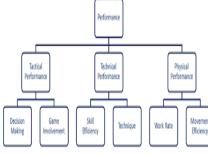
Top-Down Approach



To understand a complex system



- Top down approach (Hierarchical approach)
- A hierarchical system is a set of interrelated subsystems, each of the latter, in turn, hierarchical in structure until we reach some lowest level of elementary subsystem. At each level, the designer is concerned with structure and function.
 - Structure: The way in which the components are interrelated.
 - **Function:** The **operation** of each individual component as part of the structure.





Root: A computer

Functions:

- Data processing: Take a wide variety of data in forms and process as requirements
- Data Storage: At least store temporary data (being worked on) at short term data storage. It equally requires long term data storage
- Data movement: In a computing environments, there are various devices as source or destination of data. (input output process will be there with peripherals or memory) data communication
- **Control: Manage** computer resources and **arrange** the performance of the functional parts.



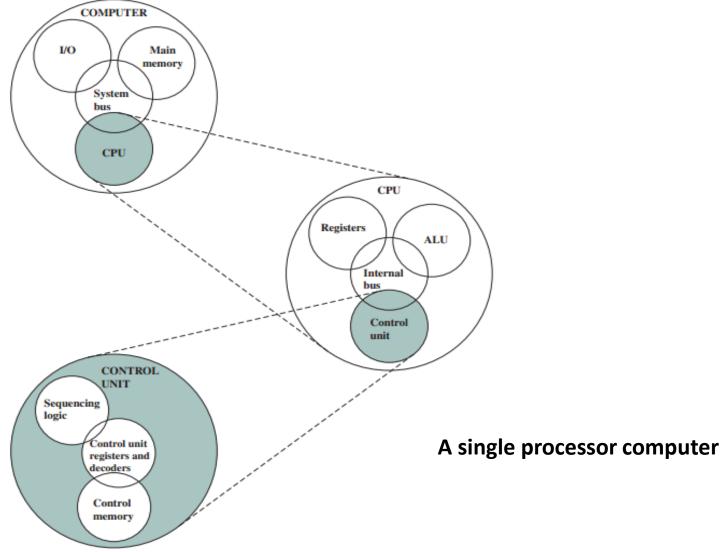
Root: A computer...

Structure: (Simple Single Processor Computer)

- Central Processing Unit: Controls the operation and performs its data processing- known as CPU or Processor
- Main Memory: Stores data
- I/O: Moves data between the computer and external world
- System Interconnection: Provides communication among CPU, memory, I/O through system bus. Keep components attached.







Lecture 1 CSE 4305: Computer Organization & Architecture 1



Root: A computer...

Major components of CPU:

- Control Unit: Controls the operation of the CPU
- Arithmetic And Logic Unit (ALU): Perform data process
- Registers: Internal storage
- **CPU Interconnection:** Provides communication among the components



Some Terminologies having same essence

Multicore Computer Structure:

- Central Processing Unit: Fetch and execute instructions containing ALU, control unit, registers – known as processor in single processor computer
- Core: An single processing unit on processor chip. Functionally equivalent to a CPU on a single CPU System. Special processing units also referred as core vector processor
- **Processor**: A physical piece of silicon having one or more cores which interprets and execute instructions.



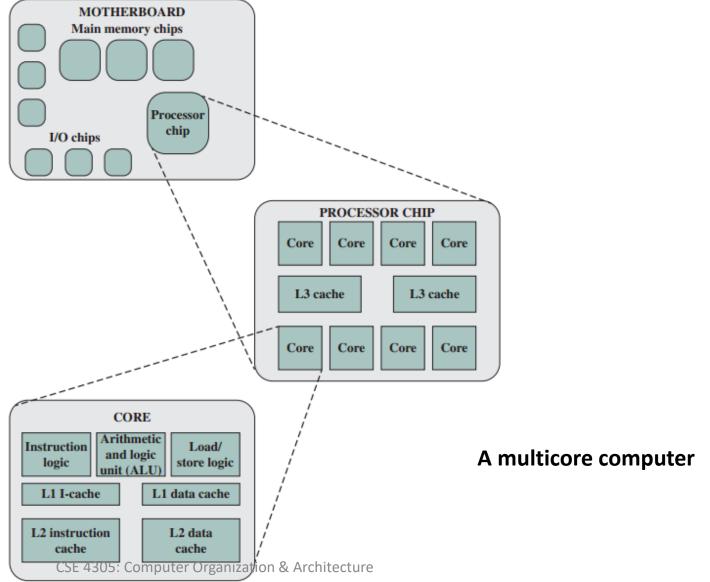
Root: A computer...

Structure: (Multicore Computer)

- Multicore Computer: <u>All processors</u> resides on <u>a single chip</u>; each <u>processing unit (named as core)</u> contains control unit, ALU, registers and cache(optional)
- Cache Memory: Memory layer between processor and main memory smaller and faster than main memory. Place data from main memory to cache to speed up the processing. It has multiple levels. Near to the core, smaller and faster than others. (L1, L2, L3...)
- Motherboard: The main PCB (printed circuit board) where the computer system is housed.
- Chips: A piece of semiconductor material upon which electronic circuit and logic gates are fabricated also known integrated circuit.



Root: A computer...



Lecture 1



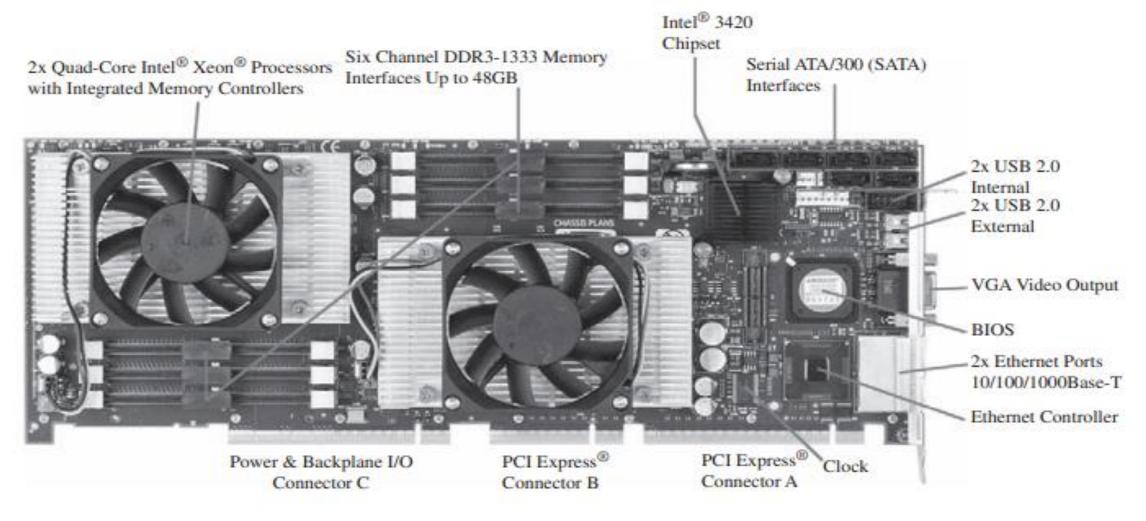
Elements of a CORE

- Instruction Logic: Fetch instructions, decode them to <u>determine the</u> <u>operation and memory location</u> of the operands
- Arithmetic Logic Unit (ALU): Performs operation specified by an instruction
- Load/Store Logic: Transfer data to and from main memory via cache
- L1 Cache: instruction cache and data cache to transfer instructions, operands and results.
- **L2 Cache**: instruction cache and data cache to transfer instructions, operands and results.



Real Life Computer - 1

Intel Quad Core Xenon Processor:





Real Life Computer – 1...

It contains:

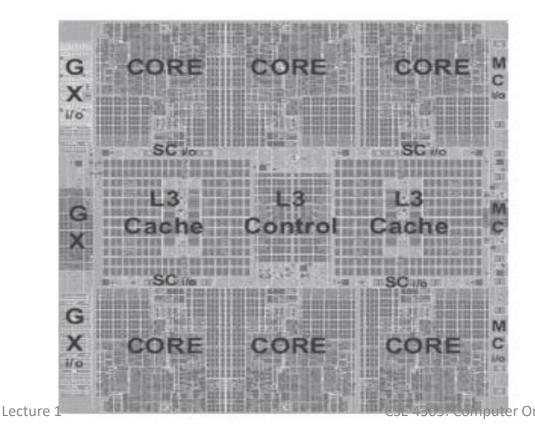
- PCI Express slots for additional displays and peripherals
- Ethernet Controller and Ethernet Port for network connections
- USB sockets for peripheral devices
- Serial ATA sockets to connect disk memory/ secondary storage
- Interface of DDR for main memory chips
- Intel 3420 chipset I/O controller for *Direct Memory Access*
- BIOS basic I/O system, non volatile firmware employed to initialize hardware during booting process.
- Clock for required clock cycle to execute each instruction



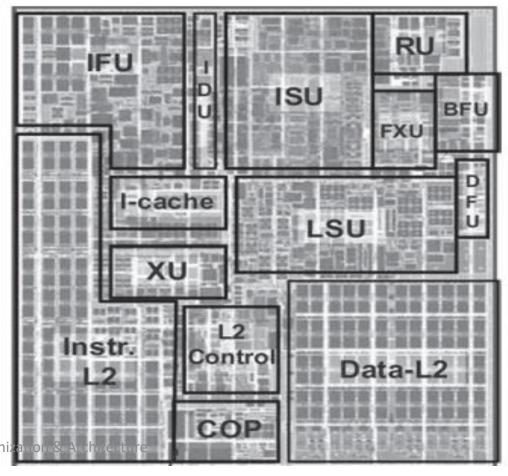
Real Life Computer - 2

IBM zEnterprise EC12 mainframe Computer

Processor Unit



Core Layout



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Real Life Computer – 2...

It contains:

- L3 Cache control: to control traffic
- Storage Control (SC): to control storage in cache
- Memory Controller (MC): to control access memory external to the chip
- GX I/O: to control the interface to access I/O



Real Life Computer – 2...

A core contains:

- Instruction Sequence Unit (ISU)
- Instruction Fetch Unit (IFU)
- Instruction Decode Unit (IDU)
- Load Store Unit (LSU) contains L1 cache
- Translation Unit (XU) translate logical address to physical Address
- Fixed Point Unit (FXU)
- Binary Floating-point Unit (BFU)
- Decimal Floating-point Unit (DFU)
- Recovery Unit (RU) keeps a copy of the complete state of the system
- Dedicated Co-processor (COP)
- I-cache
- L2 control
- Data L2

Fixed Point arithmetic - integers
Floating Point arithmetic - rationale



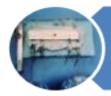
A Brief History Of Computers: Overview



First Generation (The period of first generation: 1946-1959. Vacuum tube based.)



Second Generation (The period of second generation: 1959-1964. Transistor based.)



Third Generation (The period of third generation: 1964-1971. Integrated Circuit based.)



Fourth Generation (The period of fourth generation: 1971-1980. VLSI microprocessor based.)



Fifth Generation (The period of fifth generation: 1980-onwards. ULSI microprocessor based.)

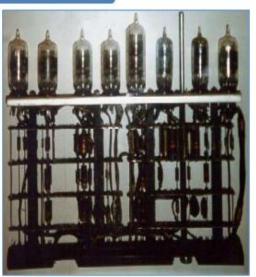


1st Generation: Vacuum Tubes

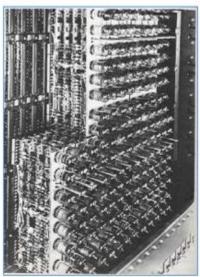
Vacuum tube for circuitry



Vacuum tube (electronic tube)

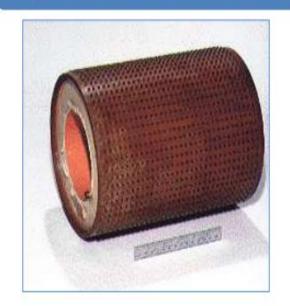


This circuit board block is one of hundreds of blocks that held the 4000 vacuum tubes for IBM's Model 701



A part of computer using vacuum tube

Magnetic drum for data store





Magnetic drum

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1st Generation...

Some computers of this generation:

ENIAC

EDVAC

UNIVAC

IBM-701

IBM-650



ENIAC



1st Generation: Main Features

- Vacuum tubes both for logic and memory elements
- Known as IAS Computer following stored program concept by John von Newmann at Princeton Institute for Advanced Studies
- Consisting of:
 - Main memory
 - ALU
 - Control Unit
 - I/O

1st Generation: IAS Structure



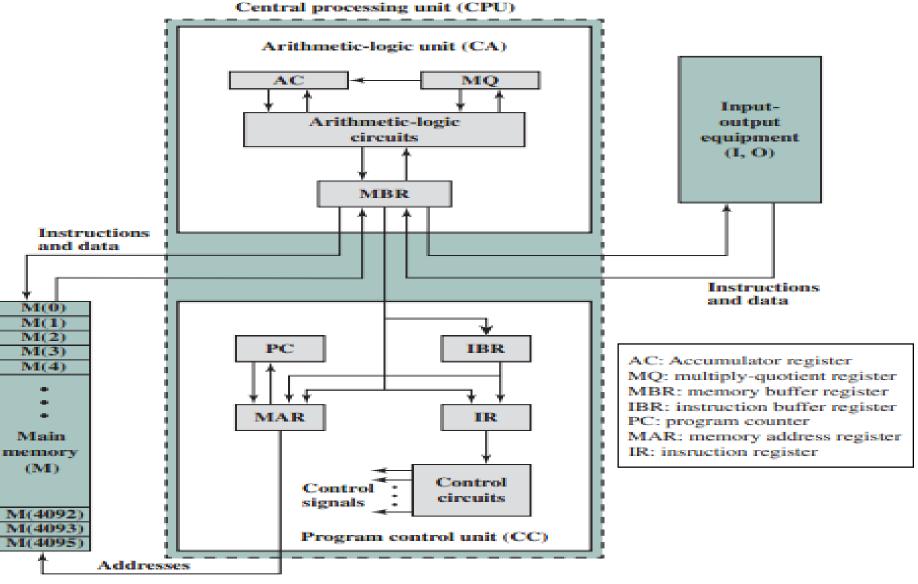


Figure 1.6 IAS Structure CSE 4305: Computer Organization & Architecture

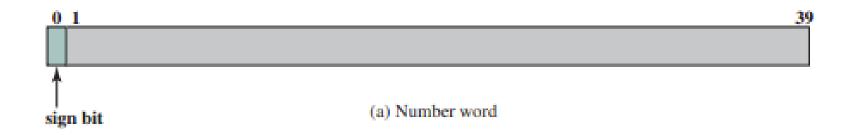


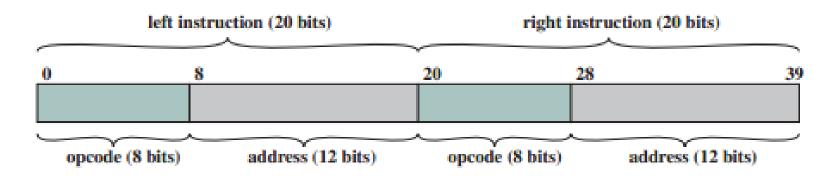
1st Generation: IAS Structure...

- In its memory, it has 4096 storage locations- called words containing 40 bits each both for data and instructions
- Data in binary form a sign bit and 39-bit value
- Instructions in binary coded form also contain two 20-bit instructions having 8-bit opcode (operation) and 12-bit address (for words in memory)
- Central Control (CC) and Central Arithmetic (CA) both have different storages – registers as MBR, MAR, IR, IBR, PC, AC, MQ
- IAS is operated based on instruction cycle 2 sub cycles: fetch and execution
- Address specifies which of the 4096 memory locations is used to execute instruction



1st Generation: IAS Memory Format

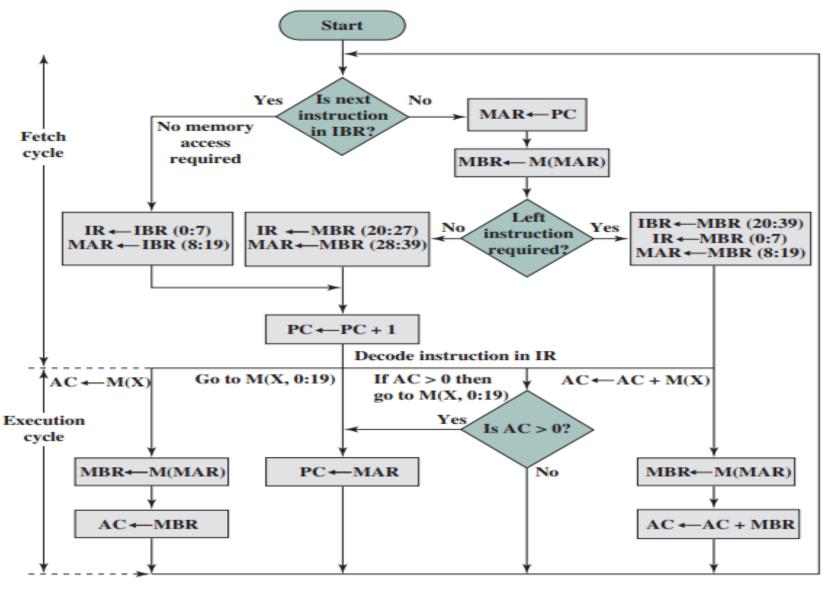




(b) Instruction word

1st Generation: IAS Instruction Cycle





1st Generation: Instruction Sets



Instruction Type	Opcode	Symbolic Representation	Description
туре	Opcode		· · · · · · · · · · · · · · · · · · ·
Data transfer	00001010	LOAD MQ	Transfer contents of register MQ to the accumulator AC
	00001001	LOAD MQ,M(X)	Transfer contents of memory location X to MQ
	00100001	STOR M(X)	Transfer contents of accumulator to memory location X
	00000001	LOAD M(X)	Transfer M(X) to the accumulator
	00000010	LOAD -M(X)	Transfer -M(X) to the accumulator
	00000011	LOAD M(X)	Transfer absolute value of M(X) to the accumulator
	00000100	LOAD - M(X)	Transfer - M(X) to the accumulator
Unconditional branch	00001101	JUMP M(X,0:19)	Take next instruction from left half of M(X)
	00001110	JUMP M(X,20:39)	Take next instruction from right half of M(X)
Conditional branch	00001111	JUMP + M(X,0:19)	If number in the accumulator is nonnegative, take next instruction from left half of M(X)
	00010000	JUMP + M(X,20:39)	If number in the accumulator is nonnegative, take next instruction from right half of $M(X)$
Arithmetic	00000101	ADD M(X)	Add M(X) to AC; put the result in AC
	00000111	ADD M(X)	Add M(X) to AC; put the result in AC
	00000110	SUB M(X)	Subtract M(X) from AC; put the result in AC
	00001000	SUB M(X)	Subtract M(X) from AC; put the remainder in AC
	00001011	MUL M(X)	Multiply M(X) by MQ; put most significant bits of result in AC, put least significant bits in MQ
	00001100	DIV M(X)	Divide AC by M(X); put the quotient in MQ and the remainder in AC
	00010100	LSH	Multiply accumulator by 2; that is, shift left one bit position
	00010101	RSH	Divide accumulator by 2; that is, shift right one position
	00010010	STOR M(X,8:19)	Replace left address field at M(X) by 12 rightmost bits
Address modify	00010011	CSE 4305: Computer STOR M(X,28:39)	Organization & Architecture Replace right address field at M(X) by 12 rightmost bits

Lecture 1



2nd Generation: Transistors







A replica of the first working transistor.

Philco surface-barrier transistor developed and produced in 1953

Assorted discrete transistors

Instead of vacuum tubes, here transistors were used.



2nd Generation: Main Features

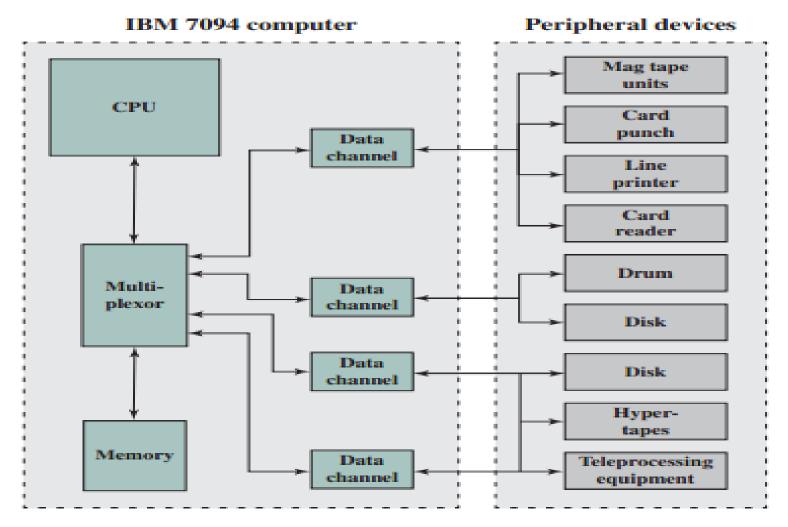
- Replacement of vacuum tubes by transistors smaller, cheaper, less heat generator all components were then made of silicon, so no wires, metal plates, glass capsule, vacuum
- More complex arithmetic and logic units and control units
- Use high level programming languages
- Use of system software OS

System Software – build platform other software Application Software – allow user to do things

- So many improvements like **Instruction Buffer Register** which store adjacent instructions from memory to reduce memory access by about 0.5 times
- Data channels- refers to I/O module with its own processor and instruction sets now CPU is not busy with detail I/O instructions (see in the picture)
- Multiplexor refers to central termination point for data channels, CPU, Memory schedules access of the memory



2nd Generation: IBM 7094





3rd Generation: Integrated Circuits

Integrated Circuit based:

A single IC has many transistors, resistors and capacitors along with the associated circuitry. The IC was invented by **Jack Kilby**. This development made computers smaller in size, reliable and efficient.







First IC

Hitachi IC

R288-SOUNDGIN-IC



3rd Generation: Why???



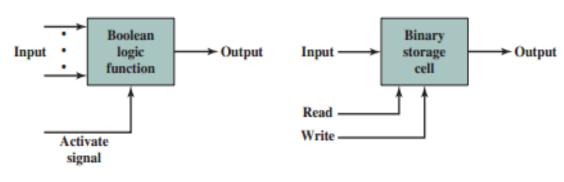
- **Electronic equipment** was composed of **discrete components** transistors, resistors, capacitors and so on and <u>soldiered or wired</u> onto the circuit board which then installed in computers
- The entire manufacturing process from transistors to circuit board was very expensive and cumbersome
- Problems increased when the number of transistors grew to the hundreds of thousands !!!



3rd Generation: Digital Electronics (???)

Microelectronics:

- Small electronics
- Gates and memory cell fundamental components made of transistors and capacitors
- Gates implement logical function (AND, OR, ...)- control data flow
- Memory cell store 1 bit in 2 stable states (0,1)
- Interconnection of the large numbers of these devices makes a computer
 - Data storage by memory cells
 - Data Processing by gates
 - **Data movement** by gates through cells
 - Control by gates through cells



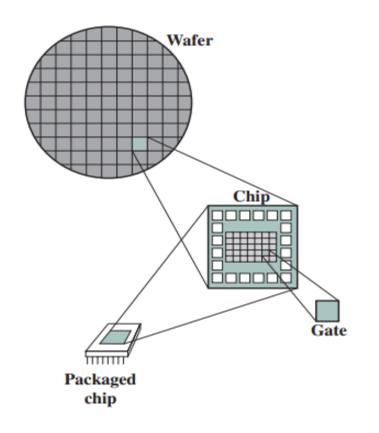


3rd Generation: Integrated Circuits (???)

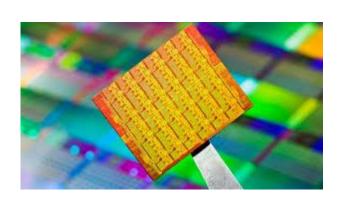
- IC exploits the fact that it fabricates all the fundamental components from silicon (semiconductor)
- Like <u>fabricating an entire circuit in a tiny piece of silicon</u> rather than assembling discrete components producing many transistors on a single wafer of silicon connected through **metallization** to form circuit
- A thin silicon wafer divided into a matrix of small areas, each a few millimeters square – having identical circuit pattern – named as chips, having many gates and/or memory cells I/O attachments points
- Chips are packaged for protection and interconnected on a PCB for complex circuit – provides pins for attachment to devices.

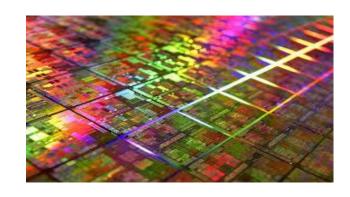


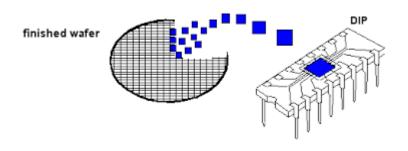
Relationship among Wafer, Chip & Gate











https://www.youtube.com/watch?v=aWVywhzuHnQ



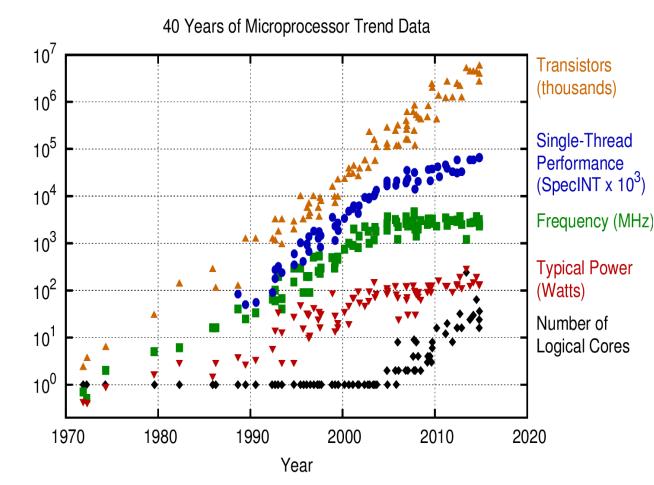
3rd Generation: Integrated Circuits...

- Classification of ICs based on their size:
 - **SSI**: Small scale integration. 3 30 gates per chip.
 - MSI: Medium scale integration. 30 300 gates per chip.
 - **LSI**: Large scale integration. 300 3,000 gates per chip.
 - VLSI: Very large scale integration. More than 3,000 gates per chip.
 - **ULSI**: Ultra large scale integration. On the top of others
- The growth in Density follows the famous Moore's Law.
- Observation of Moore's Law: The number of transistors on a chip doubles every year while the costs are halved.
- But the pace is now slowed to a doubling every 18 months.



3rd Generation: Consequences of Moore's Law

- The cost of computer Logic and memory circuit has fallen at a dramatic rate
- Logic and gates are placed closer in circuit – electrical path is shortened – increase operating speed
- Computer becomes smaller in size
- Reduction of power requirement
- With more circuitry on each chip, fewer inter chip connections (more reliable than solder connections)



Original data up to the year 2010 collected and plotted by M. Horowitz, F. Labonte, O. Shacham, K. Olukotun, L. Hammond, and C. Batten New plot and data collected for 2010-2015 by K. Rupp



3rd Generation: IBM SYSTEM/ 360

- **Bad News:** the 360 product line was **incompatible** with older IBM machines to break some constraints and produce system with ICs
- Paid off both financially and technically
- First planned family of computers members have differences only in execution time
- Many of its feature have become standard on other large computers



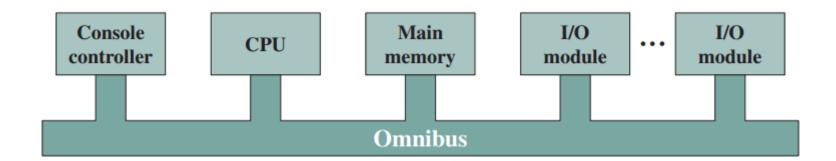
IBM SYSTEM/ 360 family: Characteristics

- Identical Instruction Set: Supported by all members of the family
- Similar Operating System: Same Basic OS
- Increasing Speed: Rate of instruction execution
- Increasing number of I/O Ports
- Increasing Memory Size
- Increasing COST (!!!) : for complexity it supports



3rd Generation: DEC PDP-8

- Built by Digital Equipment Corporation
- Small in size that it could be placed on top of a lab bench
- Cheaper enough than concurrent IBM System/ 360
- Become universal for its first introduction of BUS structure.





Later Generations

With the rapid pace of technology, the **high rate of introduction** of new products, and the importance of software and communications as well as hardware, the classification by generation becomes less clear and less meaningful.



Later Generation: Developments

Semiconductor Memory:

- IC technology also used in memory construction
- Earlier it was made of tiny rings of ferromagnetic materials magnetic core – faster but expensive and bulky and use destructive readout (erase stored data)
- Capacious Semiconductor Memory size of a single core store 256 bits
 - nondestructive access time 70X10⁻⁹ Second but higher cost



Later Generation: Developments...

Microprocessors:

- Density of elements of Processor chips increased fewer chips to construct a processor
- Breakthrough in 1971 Intel 4004 first chip containing all components of CPU in a single chip – born of microprocessor – can add and multiply – 4 bit microprocessor
- Marked as the beginning of the evolution of microprocessor
- In 1972, Intel 8008 first **8 bit single chip** microprocessor
- In 1974, Intel 8080 first **general purpose** microprocessor
- In 1981, HP and BELL lab **32 bit single chip** microprocessor



RISC and CISC Architecture Processor





RISC Architecture Processor

CISC Architecture Processor



RISC Architecture Processor: Main Features

- Represents the Reduced Instruction Set Computer
- Utilizes small and highly optimized instruction sets (smaller) needs single clock cycle to be executed – also named as LOAD/STORE architecture
- As simplified instructions are used program code is longer so software should be optimized
- Simple Addressing modes, smaller opcode, cheaper in price, faster in operation, few parameters in code, power efficient
- But more registers to reduce memory access
- Simple compiler and hardware design
- Pipelining is easier to be implemented for simple instruction
- **Used** in mobile phones, smart devices, ARM Processor (Section 1.6) (Advanced RISC Machine)



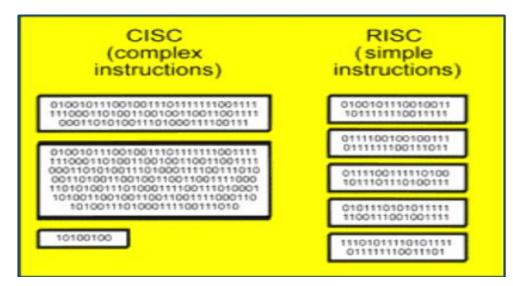
CISC Architecture Processor: Main Features

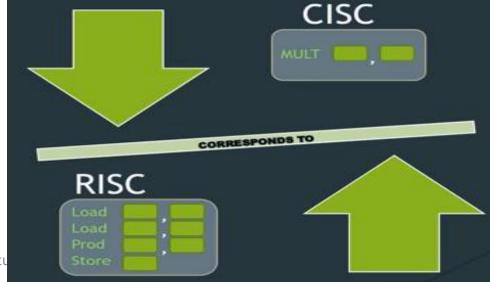
- Represents the Complex Instruction Set Computer.
- Main goal <u>completion of task by using less number of instruction lines</u> smaller <u>programming code</u> but <u>complex instructions</u> – <u>Hardware</u> can be complex – complex <u>decoding</u>
- Multi clock cycles required for per instruction execution
- More **Addressing modes**, more **memory access** for operands
- Less **number of registers** in processor
- Pipelining is difficult to be implemented for complex instructions
- Support microprogramming/ micro coding low level code –instructions are groups of microprogram codes and executed accordingly that defines how microprocessor execute instructions – inbuilt in main memory of the processor – faster than memory access
- Used in laptop, general purpose PCs, x86 processor (Section 1.4)



RISC and CISC Architecture Processor

- Both perform decode and execute phase in instruction execution
- RISC is highly efficient but has many lines of code whereas CISC has several lines of instructions
- RISC is simple and more cost efficient than CISC (comparing mobile phones with PCs)
- BUT nowadays we use their hybrid







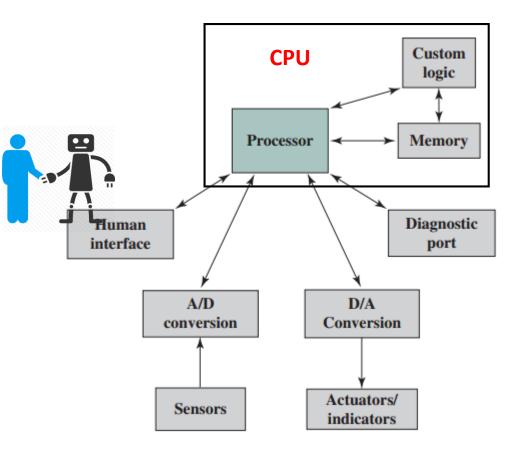
Embedded Systems

- Refers to the use of electronics and software within a product – opposite to a general purpose computer.
- Sometimes tightly coupled to the environment – to meet real time constraints





Embedded Systems: System Organization

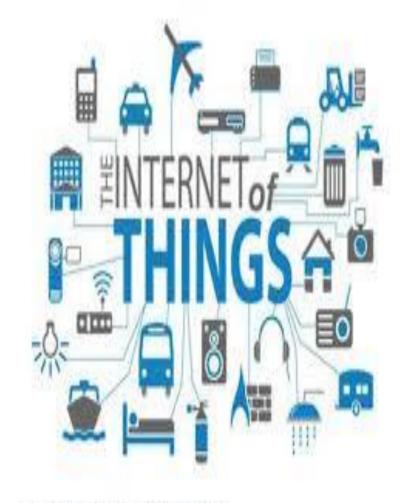


- Several Interfaces for measurement, manipulation and interaction (sense, manipulate, communicate) with external world
- Human interface to interact with human
- **Diagnostic port** diagnose the system itself
- **Special hardware** may be used to increase performance
- Application specific software
- Optimized energy, code size, execution time, weight, dimensions, cost
- **Embedded operating system** existing OS (adapted for embedded system) and OS intended solely for embedded use
- Deeply Embedded System subset of embedded system use microcontroller rather than microprocessor – dedicated for a specific purpose



Internet of Things (IoT)

- It refers to **expanding interconnections** of smart devices ranging from appliances to tiny sensors
- The theme is the <u>embedding of short range mobile</u> transceivers into a wide array of gadgets and everyday <u>items</u> –enables <u>new form of communication</u> among people, things and themselves
- Driven by embedded devices
- Internet support this interconnection through cloud system



Kuva 1. Internet of Things: Lähde: Huffington Past



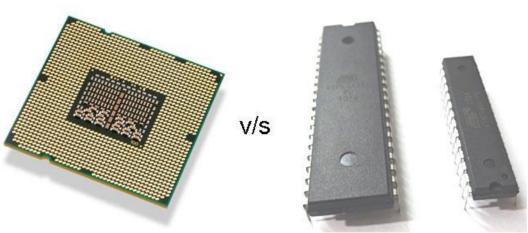
Application and Dedicated Processor

- Application processor: able to execute complex OS such as Linux,
 Windows general purpose in nature in smartphones
- Dedicated processor: dedicated for one or small number of specific tasks required by the host device

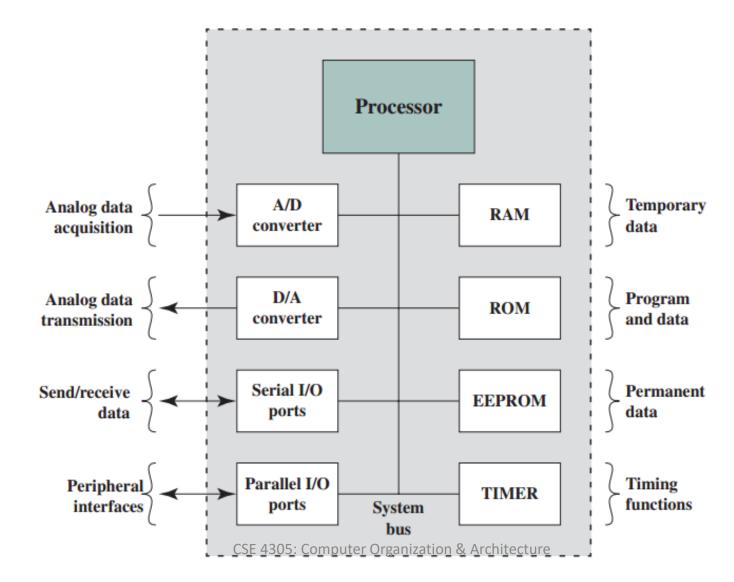


Microprocessors VS Microcontrollers

- Microprocessor includes registers, ALU, Control unit, instruction processing logic – also multiple cores and cache memory
- Microcontroller is a single chip containing processor, ROM, RAM, clock, I/O control unit computer on a chip
 - **Slowe**r than microprocessor also has smaller area for processing in processor
 - Not provide human interaction
 - **Programmed** for a specific task
 - Embedded in a device



Microcontroller: Block Diagram





Cloud Computing

- Internet connected infrastructure known as enterprise cloud computing – mostly used by large organizations for IT operations
- Single user of PCs and mobile devices also relies on cloud computing
 back up, synch, share using personal cloud computing
- Top benefits economics of scale, professional network management, professional security management – attractive to the companies
- Users only pay for storage capacity and services they need



Cloud Computing...

Cloud computing: A model for **enabling** ubiquitous, convenient, on-demand **network access** to **a shared pool of configurable computing resources** (e.g., networks, servers, storage, applications, and services) that can be rapidly **provisioned** (temporary) **and released with minimal management effort** or service provider interaction.

The user, be it company or individual, doesn't have the hassle of setting up a
database system, acquiring the hardware they need, doing maintenance, and
backing up the data — all these are part of the cloud service.



Cloud Computing...

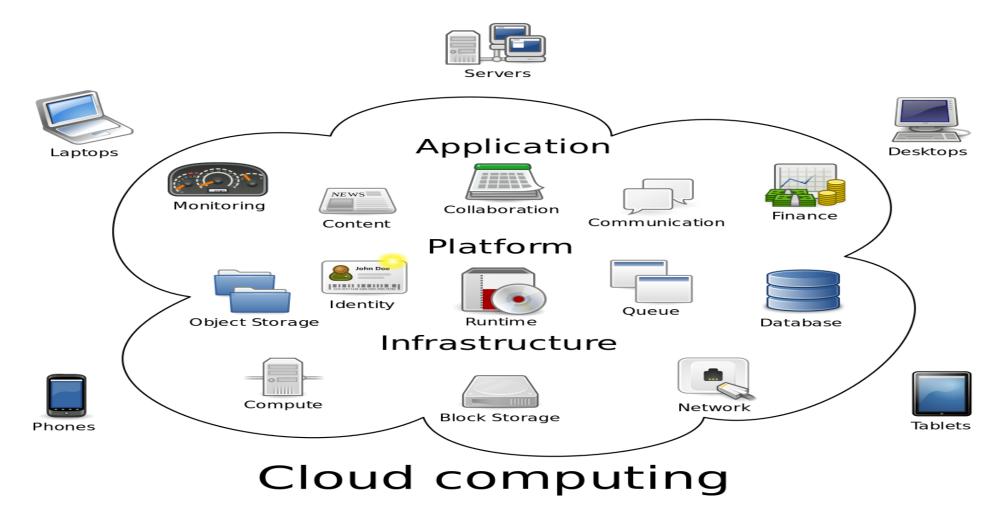
- Cloud Networking networks and its management to enable cloud computing
 - Internet is very crucial for all tasks in cloud high performance and high reliability should be ensured between provider and subscribers
 - This INTERNET can be bypassed dedicated private network owned by cloud services – provides all the services on the behalf real INTERNET – like access cloud, link with data centers, use of firewalls, network security
- Cloud storage consisting of database storage, database applications (controlled cloud servers) – gives access form small business to individuals - without buy, maintain, and manage



Cloud Services

- **Software as a Service** (SaaS) service **in the form of software** to run and access that software in cloud. Same model of Web services.
- Platform as a Service (PaaS) service in the form of a platform on which customer's applications can run. Also some development tools to develop new applications
- Infrastructure as a Service (laaS) through this service customers
 has access to underlying infrastructure using virtual machine,
 abstracted hardware, operating systems which are controlled
 through API Windows AZURE, Amazon ELASTIC

Cloud Services...





New Slide